1	58817	resist WITH pattern	USPAT; EPO; JPO; DERWENT; IBM_TDB
2	3394	(resist WITH pattern) SAME photolithography	USPAT; EPO; JPO; DERWENT; IBM_TDB
3	4817	(resist WITH pattern) SAME photolithograph$?	USPAT; EPO; JPO; DERWENT; IBM_TDB
4	6	((resist WITH pattern) SAME photolithograph$?) SAME polariz$?	USPAT; EPO; JPO; DERWENT; IBM_TDB
6	667	(mold$? OR pressing) WITH photoresist	USPAT; EPO; JPO; DERWENT; IBM_TDB
7	128	((mold$? OR pressing) WITH photoresist) SAME etching	USPAT; EPO; JPO; DERWENT; IBM_TDB
8	163000	emboss$? OR photoresist	USPAT; EPO; JPO; DERWENT; IBM_TDB
9	181	emboss$? WITH photoresist	USPAT; EPO; JPO; DERWENT; IBM_TDB
10	89	216/44[ccls]	USPAT; EPO; JPO; DERWENT;

L Number	Hits	Search Text ✓ SAME ✓ : yleld 80 Hits, none relevant	DB
16	0	(((mold OR mask$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating	USPAT; EPO; JPO; DERWENT; IBM_TDB
14	2	((mold OR mask$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)	USPAT; EPO; JPO; DERWENT; IBM_TDB
13	43	(mold OR mask$?) WITH (wire-grid OR (wire ADJ1 grid))	USPAT; EPO; JPO; DERWENT; IBM_TDB
-	1443	AR ADJ1 coat$?	USPAT; EPO; JPO; DERWENT; IBM_TDB
-	13592	antireflect$?	USPAT; EPO; JPO; DERWENT; IBM_TDB
-	16824	anti ADJ1 reflect$?	USPAT; EPO; JPO; DERWENT; IBM_TDB
-	9	((AR ADJ1 coat$?) OR antireflect$? OR (anti ADJ1 reflect$?)) WITH (wire-grid OR (wire ADJ1 grid))	USPAT; EPO; JPO; DERWENT; IBM_TDB